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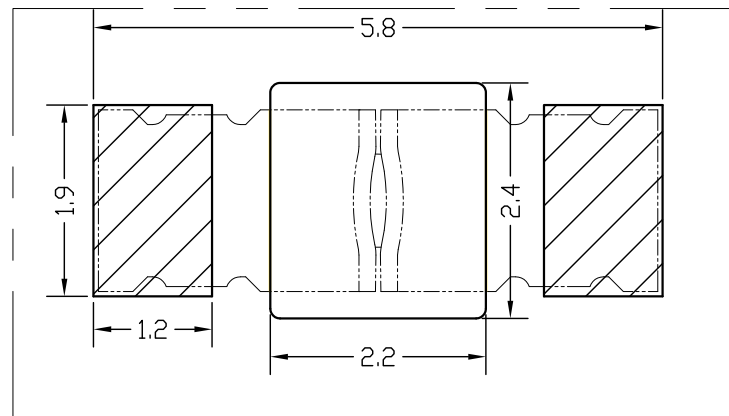
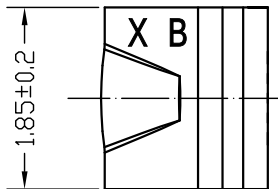
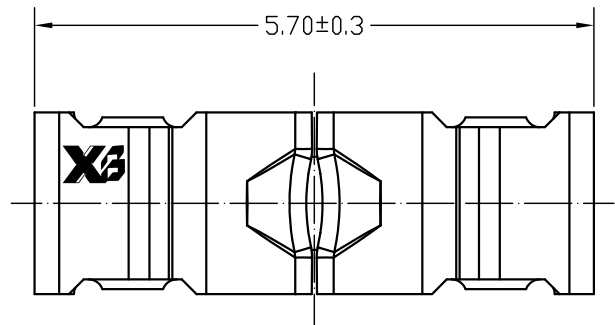
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REV	ECN No.	DESCRIPTION	DESIGN	DATE
A0		Release	蒋建银	2017.03.23

1



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2

PCB LAYOUT

主要技术参数 Main Specifications

线 数 (Poles): 01

接触电阻 (Contact resistance): $\leq 30\text{m}\Omega$

额定电压 (Rated voltage): 275V AC DC

额定电流 (Rated current): 1.0A AC DC

温度范围 (Temperature Range): $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$

ORDER INFORMATION:

XB- L080K-01-000B1-R

PART No.

No. FOR CIRCUITS:

01

PLASTIC MATERIAL:

000=No plastic parts

PACKAGING:

R=REEL

METAL CODE:

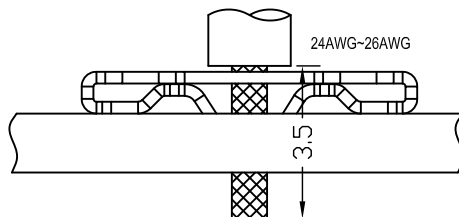
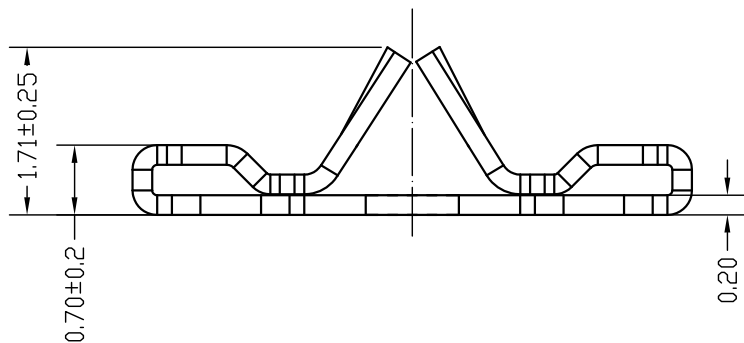
1=PhosphorBronze

PLATING:

B=MATTE Sn

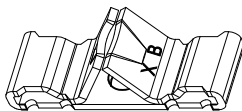
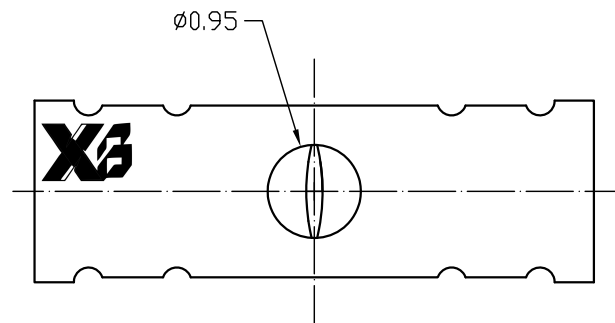
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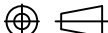


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C					
B					
A	CONTACT		1 PCS	PhosphorBronze	MATTE Sn-plated
ITEM	COMPONENT		Q'TY	MATERIAL	FINISH
 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD TITLE:					
X.±0.5	X.±5'	USE:		PART NO.:	
.X±0.3	.X±2'	CUSTOMER		L080K-01-000B1-R	
.XX±0.25	.XX±1'	APPD:		DWG NO.:	
		邵敬和		GCCP-1096	
--	--	CHKD:		SCALE	
		田峰		SHEET	
	UNITS: mm	DR:		1 : 1	1 / 1
		蒋建银			

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